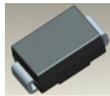


## Features

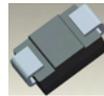
- Ultra Low Forward Voltage Drop
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **Green Molding Compound (No Halogen and Antimony) (Note 2)**

## Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish.) Solderable per MIL-STD-202, Method 208 
- Polarity Indicator: Cathode Band
- Weight: 0.064 grams (approximate)



Top View



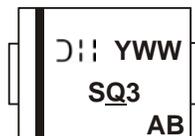
Bottom View

## Ordering Information (Note 3)

Part Number	Case	Packaging
SBR2U30SA -13	SMA	5000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
  2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
  3. For packaging details, go to our website at <http://www.diodes.com>.

## Marking Information



SQ3 = Product Type Marking Code  
 = Manufacturers' code marking  
 YWW = Date Code Marking  
 Y = Last digit of year (ex: 7 for 2007)  
 WW = Week code (01 to 53)  
 AB = Foundry and Assembly Code

**Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	30	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>RM</sub>		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	21	V
Average Rectified Output Current (See Figure 1)	I <sub>O</sub>	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	30	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance			
Thermal Resistance Junction to Soldering (Note 4)	R <sub>θJS</sub>	5	°C/W
Thermal Resistance Junction to Ambient (Note 5)	R <sub>θJA</sub>	128	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	TYP	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	30	-	-	V	I <sub>R</sub> = 400 μA
Forward Voltage Drop	V <sub>F</sub>		0.21	0.26	V	I <sub>F</sub> = 0.1A, T <sub>J</sub> = 25°C
			0.11	0.15		I <sub>F</sub> = 0.1A, T <sub>J</sub> = 125°C
			0.31	0.35		I <sub>F</sub> = 1.0A, T <sub>J</sub> = 25°C
			0.23	0.30		I <sub>F</sub> = 1.0A, T <sub>J</sub> = 125°C
			0.36	0.40		I <sub>F</sub> = 2.0A, T <sub>J</sub> = 25°C
			0.30	0.33		I <sub>F</sub> = 2.0A, T <sub>J</sub> = 125°C
Leakage Current (Note 6)	I <sub>R</sub>		210	500	μA	V <sub>R</sub> = 30V, T <sub>J</sub> = 25 °C
			23	100	mA	V <sub>R</sub> = 30V, T <sub>J</sub> = 125 °C

- Notes:
- Theoretical R<sub>θJS</sub> calculated from the top center of the die straight down to the PCB cathode tab solder junction.
  - FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>. T<sub>A</sub> = 25°C
  - Short duration pulse test used to minimize self-heating effect.

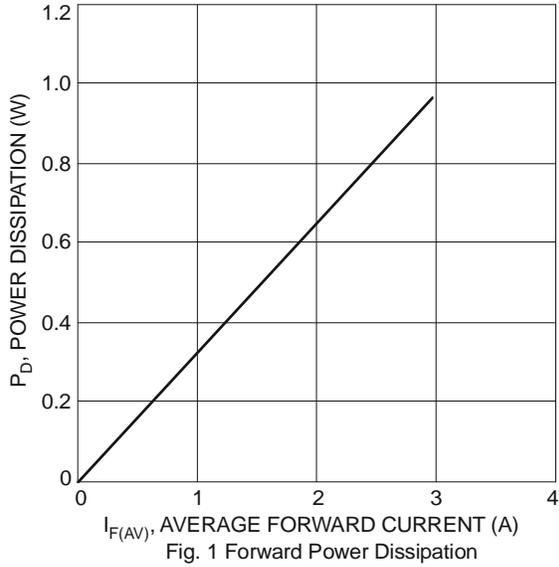


Fig. 1 Forward Power Dissipation

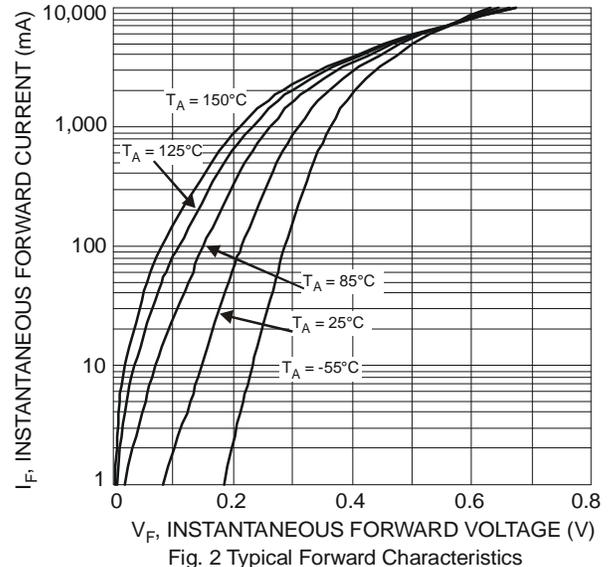


Fig. 2 Typical Forward Characteristics

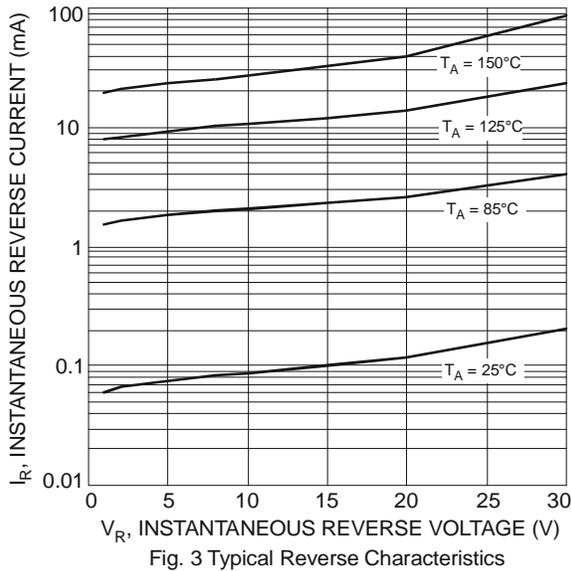


Fig. 3 Typical Reverse Characteristics

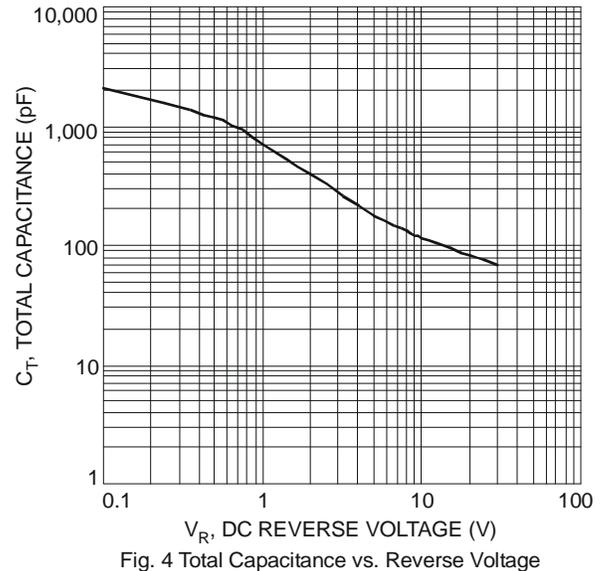


Fig. 4 Total Capacitance vs. Reverse Voltage

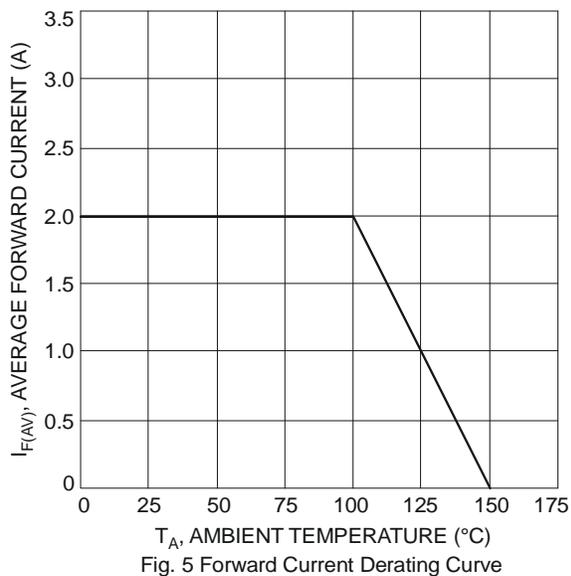


Fig. 5 Forward Current Derating Curve

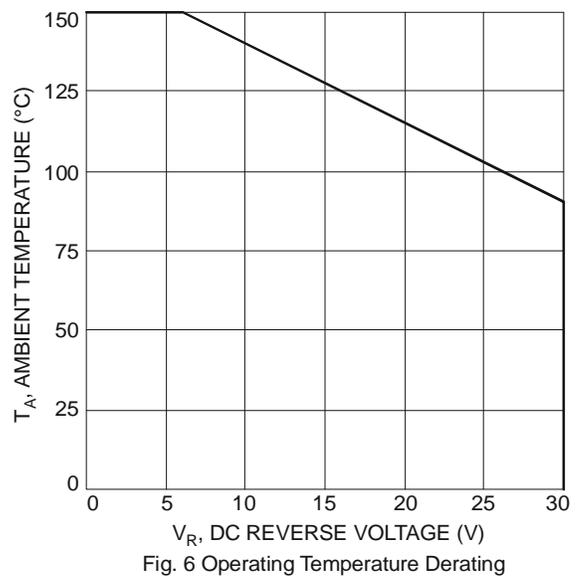
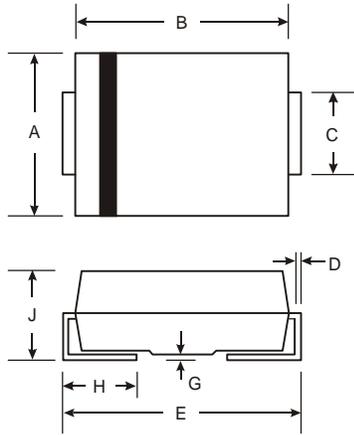


Fig. 6 Operating Temperature Derating

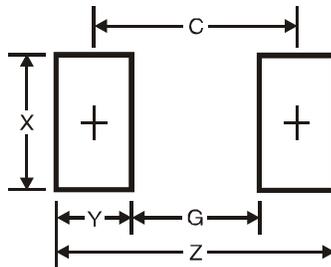
**Package Outline Dimensions**



SMA		
Dim	Min	Max
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	2.01	2.30

All Dimensions in mm

**Suggested Pad Layout**



Dimensions	Value (in mm)
Z	6.5
G	1.5
X	1.7
Y	2.5
C	4.0

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